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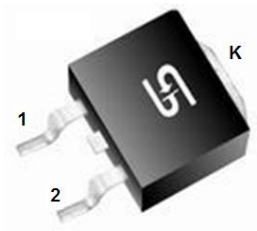
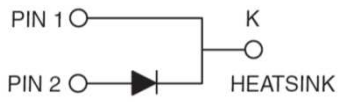
10A, 600V Surface Mount Super Fast Rectifier

FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- High efficiency, low VF
- High surge current capability
- Low power loss
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21



TO-263AB (D^2PAK)



Pb-Free

RoHS COMPLIANT

MECHANICAL DATA

Case: TO-263AB (D^2PAK)
Molding compound: UL flammability classification rating 94V-0
Moisture sensitivity level: level 1, per J-STD-020
Part no. with suffix "H" means AEC-Q101 qualified
Packing code with suffix "G" means green compound (halogen-free)
Terminal: Matte tin plated leads, solderable per JESD22-B102
Meet JESD 201 class 2 whisker test
Polarity: As marked
Weight: 1.33 g (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	SFAS1008G	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	600	V
Maximum RMS voltage	V_{RMS}	420	V
Maximum DC blocking voltage	V_{DC}	600	V
Maximum average forward rectified current	$I_{F(AV)}$	10	A
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	125	A
Maximum instantaneous forward voltage I_F= 10 A	V_F	1.7	V
Maximum reverse current @ rated V_R T_J=25°C T_J=100°C	I_R	10 400	μA
Maximum reverse recovery time (Note 1)	t_{rr}	35	ns
Typical junction capacitance (Note 2)	C_J	60	pF
Typical thermal resistance	$R_{\theta JC}$	2.2	°C/W
Operating junction temperature range	T_J	- 55 to +150	°C
Storage temperature range	T_{STG}	- 55 to +150	°C

Note 1: Test conditions: I_F=0.5A, I_R=1.0A, I_{RR}=0.25A

Note 2: Measured at 1 MHz and applied reverse voltage of 4.0V DC.

ORDERING INFORMATION					
PART NO.	**PART NO. SUFFIX**	**PACKING CODE**	**PACKING CODE SUFFIX (*)**	**PACKAGE**	**PACKING**
SFAS1008G	H	RN	G	D^2PAK	800 / 13" Paper reel
		MN			800 / 13" Plastic reel

*: Optional available

EXAMPLE					
EXAMPLE P/N	**PART NO.**	**PART NO. SUFFIX**	**PACKING CODE**	**PACKING CODE SUFFIX**	**DESCRIPTION**
SFAS1008GHRNG	SFAS1008G	H	RN	G	AEC-Q101 qualified Green compound

RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)

FIG.1 FORWARD CURRENT DERATING CURVE

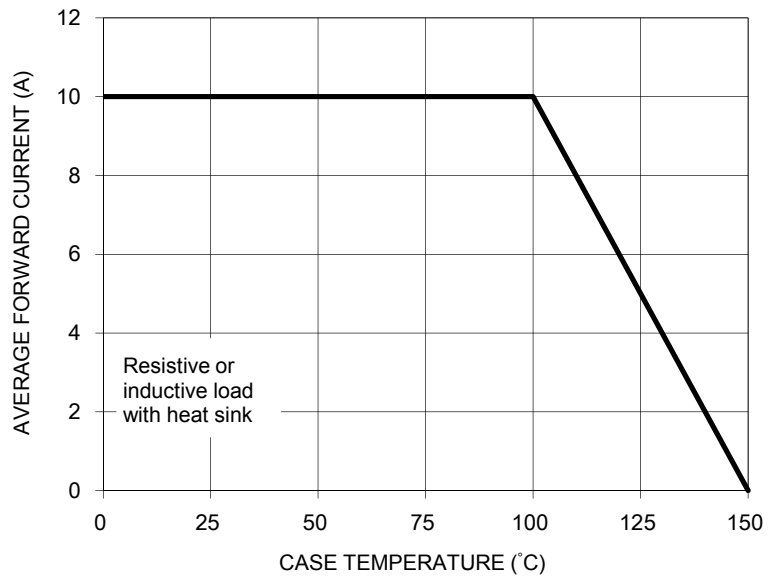


FIG. 2 TYPICAL REVERSE CHARACTERISTICS

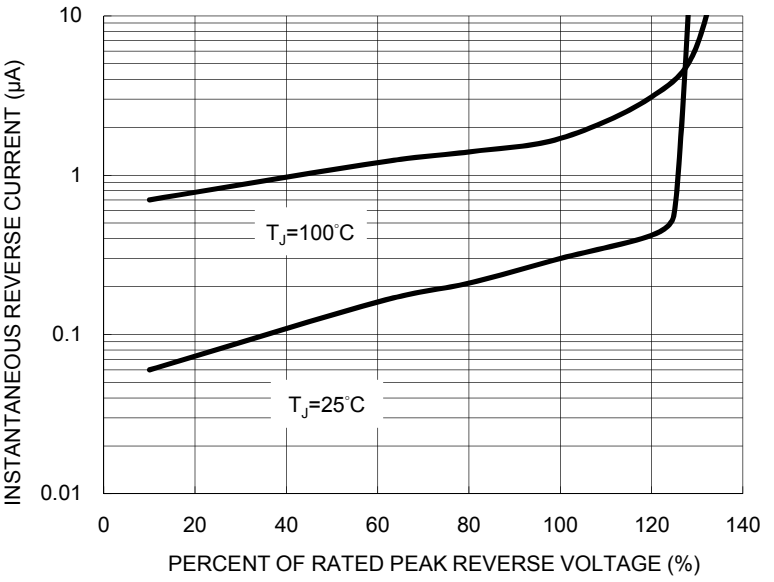


FIG. 3 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

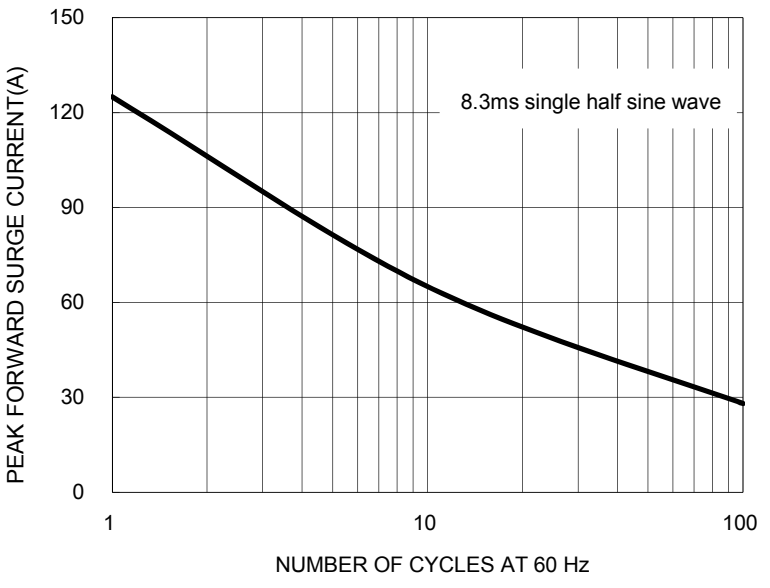


FIG. 4 TYPICAL FORWARD CHARACTERISTICS

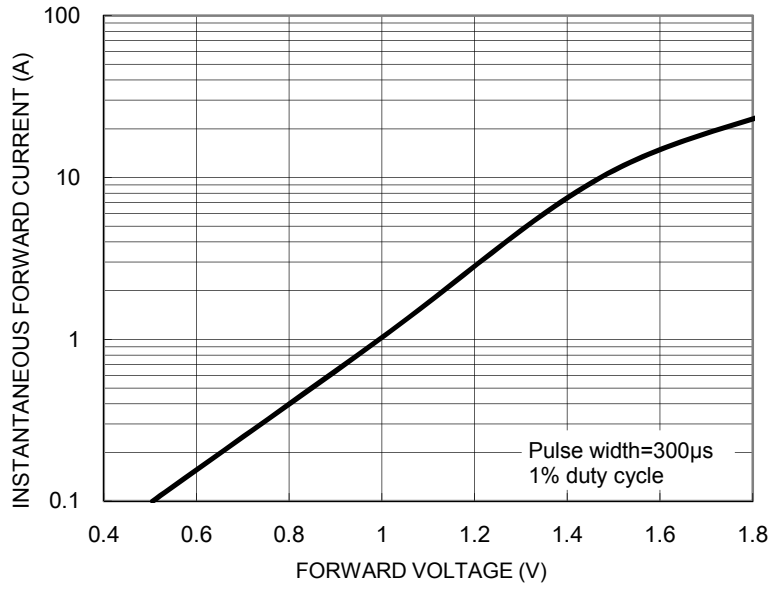


FIG. 5 TYPICAL JUNCTION CAPACITANCE

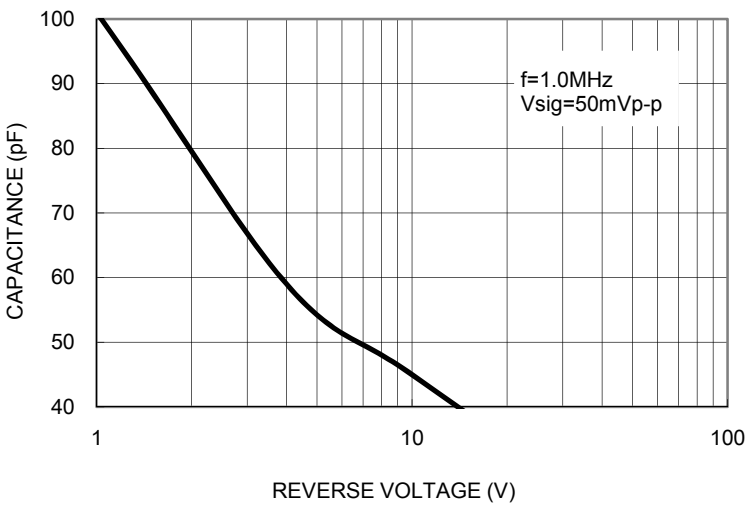
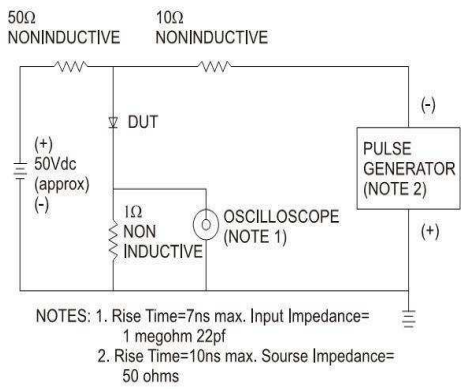
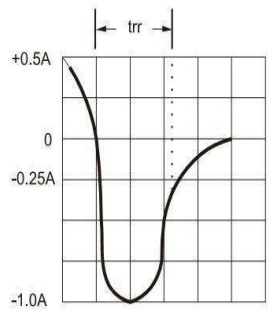


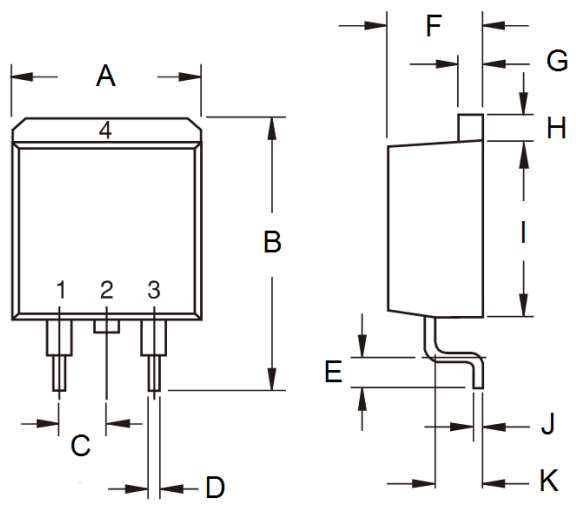
FIG.6 REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM





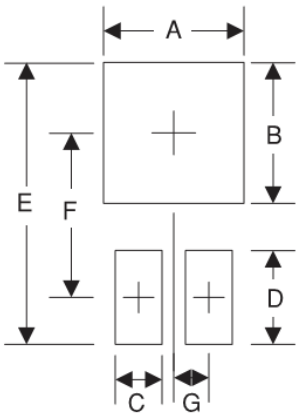
PACKAGE OUTLINE DIMENSIONS

TO-263AB (D²PAK)



DIM.	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	-	10.5	-	0.413
B	14.60	15.88	0.575	0.625
C	2.41	2.67	0.095	0.105
D	0.68	0.94	0.027	0.037
E	2.29	2.79	0.090	0.110
F	4.44	4.70	0.175	0.185
G	1.14	1.40	0.045	0.055
H	1.14	1.40	0.045	0.055
I	8.25	9.25	0.325	0.364
J	0.36	0.53	0.014	0.021
K	2.03	2.79	0.080	0.110

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	10.8	0.425
B	8.3	0.327
C	1.1	0.043
D	3.5	0.138
E	16.9	0.665
F	9.5	0.374
G	2.5	0.098

MARKING DIAGRAM

P/N = Specific Device Code
G = Green Compound
YWW = Date Code
F = Factory Code

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